



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

1702
PATENT

Applicant: Kumar et al.	Examiner: B. Talbot
Serial No. 09/903,114	Group Art Unit: 1762
Filed: July 11, 2001	
For: THERMAL PROCESSING SYSTEM AND METHODS FOR FORMING LOW-K DIELECTRIC FILMS SUITABLE FOR INCORPORATION INTO MICROELECTRONIC DEVICES	Docket No. FSI0006/US/2

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Commissioner for Patents
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I CERTIFY THAT ON Oct. 14, 2003, THIS PAPER IS
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FEE AMENDMENT, COMMISSIONER FOR PATENTS, P.O. BOX
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Paula J. Breeden
PAULA J. BREEDEN

RESPONSE

Dear Sir or Madam:

This communication is responsive to the non-final Office Action, mailed July 14, 2003,
regarding the above-mentioned patent Application.

The three-month shortened statutory period for response is set to expire on October 14, 2003. It is respectfully submitted that this response, filed on October 14, 2003, is timely filed within the shortened statutory period. However, if any extension of time is required in order for this paper to be timely filed, then such extension of time is hereby requested and the Commissioner is authorized to charge any extension of time fees to the Kagan Binder deposit account No. 50-1775 and thereafter notify us of the same.

No other fees are believed to be required in connection with the filing of this Response. However, should any fee be required, the Commissioner is authorized to charge such fee(s) to the Kagan Binder Deposit Account No. 50-1775 and thereafter notify us of the same.